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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	R32C/100
Core Size	16/32-Bit
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I ² C, IEBus, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	120
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	63K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 34x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f64178dfd-ub

Table 1.6 R32C/117 Group Product List for High Speed Version (2/2) As of February, 2013

Part Number	Package Code ⁽¹⁾	ROM Capacity ⁽²⁾	RAM Capacity	Remarks
R5F6417BHNFB (P)	PLQP0100KB-A	128 Kbytes + 8 Kbytes	20 Kbytes	-20°C to 85°C (N version)
R5F6417BHDFB				-40°C to 85°C (D version)
R5F6417BHPFB				-40°C to 85°C (P version)
R5F6417AHNFB (P)	PLQP0100KB-A	256 Kbytes + 8 Kbytes		-20°C to 85°C (N version)
R5F6417AHDFB				-40°C to 85°C (D version)
R5F6417AHPFB				-40°C to 85°C (P version)
R5F64175HNFD (P)	PLQP0144KA-A	384 Kbytes + 8 Kbytes	40 Kbytes	-20°C to 85°C (N version)
R5F64175HDFD				-40°C to 85°C (D version)
R5F64175HPFD				-40°C to 85°C (P version)
R5F64175HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64175HDFB				-40°C to 85°C (D version)
R5F64175HPFB				-40°C to 85°C (P version)
R5F64176HNFD (P)	PLQP0144KA-A	512 Kbytes + 8 Kbytes		-20°C to 85°C (N version)
R5F64176HDFD				-40°C to 85°C (D version)
R5F64176HPFD				-40°C to 85°C (P version)
R5F64176HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64176HDFB				-40°C to 85°C (D version)
R5F64176HPFB				-40°C to 85°C (P version)
R5F64177HNFD (P)	PLQP0144KA-A	640 Kbytes + 8 Kbytes	48 Kbytes	-20°C to 85°C (N version)
R5F64177HDFD				-40°C to 85°C (D version)
R5F64177HPFD				-40°C to 85°C (P version)
R5F64177HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64177HDFB				-40°C to 85°C (D version)
R5F64177HPFB				-40°C to 85°C (P version)
R5F64178HNFD (P)	PLQP0144KA-A	768 Kbytes + 8 Kbytes	63 Kbytes	-20°C to 85°C (N version)
R5F64178HDFD				-40°C to 85°C (D version)
R5F64178HPFD				-40°C to 85°C (P version)
R5F64178HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64178HDFB				-40°C to 85°C (D version)
R5F64178HPFB				-40°C to 85°C (P version)
R5F64179HNFD (P)	PLQP0144KA-A	1 Mbyte + 8 Kbytes		-20°C to 85°C (N version)
R5F64179HDFD				-40°C to 85°C (D version)
R5F64179HPFD				-40°C to 85°C (P version)
R5F64179HNFB (P)	PLQP0100KB-A			-20°C to 85°C (N version)
R5F64179HDFB				-40°C to 85°C (D version)
R5F64179HPFB				-40°C to 85°C (P version)

(P): On planning phase

Notes:

- The old package codes are as follows:
PLQP0100KB-A: 100P6Q-A; PLQP0144KA-A: 144P6Q-A
- "8 Kbytes" in the ROM capacity indicates the data flash memory capacity.

Table 1.16 Pin Definitions and Functions (3/4)

Function	Symbol	I/O	Description
I/O port (1, 2)	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7	I/O	I/O ports in CMOS. Each port can be programmed to input or output under the control of the direction register. Some ports are 5 V tolerant inputs. Pull-up resistors and N-channel open drain setting can be enabled on some ports. Refer to Table 1.18 "Pin Specifications" for details
Input port (2)	P9_1 (for 100-pin package) P14_1 (for 144-pin package)	I	Input port in CMOS Pull-up resistor is selectable. Refer to Table 1.18 "Pin Specifications" for details
Timer A	TA0OUT to TA4OUT	I/O	Timers A0 to A4 input/output
	TA0IN to TA4IN	I	Timers A0 to A4 input
Timer B	TB0IN to TB5IN	I	Timers B0 to B5 input
Three-phase motor control timer output	U, $\bar{U}$, V, $\bar{V}$, W, $\bar{W}$	O	Three-phase motor control timer output
Serial interface	$\overline{\text{CTS0}}$ to $\overline{\text{CTS8}}$	I	Handshake input
	$\overline{\text{RTS0}}$ to $\overline{\text{RTS8}}$	O	Handshake output
	CLK0 to CLK8	I/O	Transmit/receive clock input/output
	RXD0 to RXD8	I	Serial data input
	TXD0 to TXD8	O	Serial data output
I ² C-bus (simplified)	SDA0 to SDA6	I/O	Serial data input/output
	SCL0 to SCL6	I/O	Transmit/receive clock input/output
Serial interface special functions	STXD0 to STXD6	O	Serial data output in slave mode
	SRXD0 to SRXD6	I	Serial data input in slave mode
	$\overline{\text{SS0}}$ to $\overline{\text{SS6}}$	I	Input to control serial interface special functions

Notes:

1. Port P9_1 in the 100-pin package is an input-only port.
2. Ports P9_0, P9_2, and P11 to P15 are available in the 144-pin package only.

2. Central Processing Unit (CPU)

The CPU contains the registers shown below. There are two register banks each consisting of registers R2R0, R3R1, R6R4, R7R5, A0 to A3, SB, and FB.

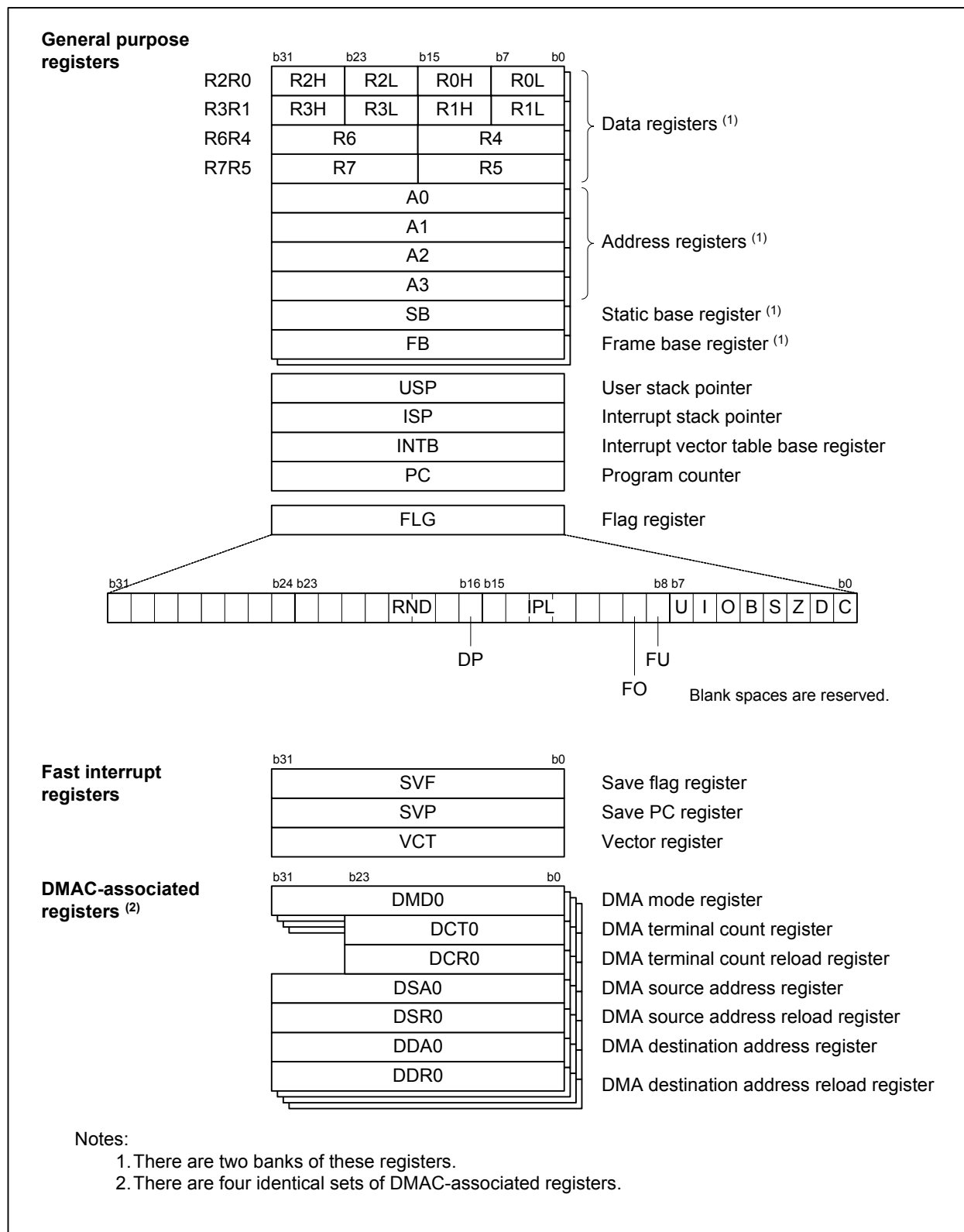


Figure 2.1 CPU Registers

Table 4.7 SFR List (7)

Address	Register	Symbol	Reset Value
000140h	Group 2 Waveform Generation Register 0	G2PO0	XXXXh
000141h			
000142h	Group 2 Waveform Generation Register 1	G2PO1	XXXXh
000143h			
000144h	Group 2 Waveform Generation Register 2	G2PO2	XXXXh
000145h			
000146h	Group 2 Waveform Generation Register 3	G2PO3	XXXXh
000147h			
000148h	Group 2 Waveform Generation Register 4	G2PO4	XXXXh
000149h			
00014Ah	Group 2 Waveform Generation Register 5	G2PO5	XXXXh
00014Bh			
00014Ch	Group 2 Waveform Generation Register 6	G2PO6	XXXXh
00014Dh			
00014Eh	Group 2 Waveform Generation Register 7	G2PO7	XXXXh
00014Fh			
000150h	Group 2 Waveform Generation Control Register 0	G2POCR0	0000 0000b
000151h	Group 2 Waveform Generation Control Register 1	G2POCR1	0000 0000b
000152h	Group 2 Waveform Generation Control Register 2	G2POCR2	0000 0000b
000153h	Group 2 Waveform Generation Control Register 3	G2POCR3	0000 0000b
000154h	Group 2 Waveform Generation Control Register 4	G2POCR4	0000 0000b
000155h	Group 2 Waveform Generation Control Register 5	G2POCR5	0000 0000b
000156h	Group 2 Waveform Generation Control Register 6	G2POCR6	0000 0000b
000157h	Group 2 Waveform Generation Control Register 7	G2POCR7	0000 0000b
000158h			
000159h			
00015Ah			
00015Bh			
00015Ch			
00015Dh			
00015Eh			
00015Fh			
000160h	Group 2 Base Timer Register	G2BT	XXXXh
000161h			
000162h	Group 2 Base Timer Control Register 0	G2BCR0	0000 0000b
000163h	Group 2 Base Timer Control Register 1	G2BCR1	0000 0000b
000164h	Base Timer Start Register	BTSR	XXXX 0000b
000165h			
000166h	Group 2 Function Enable Register	G2FE	00h
000167h	Group 2 RTP Output Buffer Register	G2RTP	00h
000168h			
000169h			
00016Ah	Group 2 Serial Interface Mode Register	G2MR	00XX X000b
00016Bh	Group 2 Serial Interface Control Register	G2CR	0000 X110b
00016Ch	Group 2 SI/O Transmit Buffer Register	G2TB	XXXXh
00016Dh			
00016Eh	Group 2 SI/O Receive Buffer Register	G2RB	XXXXh
00016Fh			

X: Undefined

Blanks are reserved. No access is allowed.

Table 4.12 SFR List (12)

Address	Register	Symbol	Reset Value
0002F0h			
0002F1h			
0002F2h			
0002F3h			
0002F4h	UART4 Special Mode Register 4	U4SMR4	00h
0002F5h	UART4 Special Mode Register 3	U4SMR3	00h
0002F6h	UART4 Special Mode Register 2	U4SMR2	00h
0002F7h	UART4 Special Mode Register	U4SMR	00h
0002F8h	UART4 Transmit/Receive Mode Register	U4MR	00h
0002F9h	UART4 Bit Rate Register	U4BRG	XXh
0002FAh	UART4 Transmit Buffer Register	U4TB	XXXXh
0002FBh			
0002FCh	UART4 Transmit/Receive Control Register 0	U4C0	0000 1000b
0002FDh	UART4 Transmit/Receive Control Register 1	U4C1	0000 0010b
0002FEh	UART4 Receive Buffer Register	U4RB	XXXXh
0002FFh			
000300h	Count Start Register for Timers B3, B4, and B5	TBSR	000X XXXXb
000301h			
000302h	Timer A1-1 Register	TA11	XXXXh
000303h			
000304h	Timer A2-1 Register	TA21	XXXXh
000305h			
000306h	Timer A4-1 Register	TA41	XXXXh
000307h			
000308h	Three-phase PWM Control Register 0	INVC0	00h
000309h	Three-phase PWM Control Register 1	INVC1	00h
00030Ah	Three-phase Output Buffer Register 0	IDB0	XX11 1111b
00030Bh	Three-phase Output Buffer Register 1	IDB1	XX11 1111b
00030Ch	Dead Time Timer	DTT	XXh
00030Dh	Timer B2 Interrupt Generating Frequency Set Counter	ICTB2	XXh
00030Eh			
00030Fh			
000310h	Timer B3 Register	TB3	XXXXh
000311h			
000312h	Timer B4 Register	TB4	XXXXh
000313h			
000314h	Timer B5 Register	TB5	XXXXh
000315h			
000316h			
000317h			
000318h			
000319h			
00031Ah			
00031Bh	Timer B3 Mode Register	TB3MR	00XX 0000b
00031Ch	Timer B4 Mode Register	TB4MR	00XX 0000b
00031Dh	Timer B5 Mode Register	TB5MR	00XX 0000b
00031Eh			
00031Fh			

X: Undefined

Blanks are reserved. No access is allowed.

Table 4.22 SFR List (22)

Address	Register	Symbol	Reset Value
0400F0h	Port P10_0 Function Select Register	P10_0S	0XXX X000b
0400F1h	Port P11_0 Function Select Register	P11_0S	X0XX X000b
0400F2h	Port P10_1 Function Select Register	P10_1S	0XXX X000b
0400F3h	Port P11_1 Function Select Register	P11_1S	X0XX X000b
0400F4h	Port P10_2 Function Select Register	P10_2S	0XXX X000b
0400F5h	Port P11_2 Function Select Register	P11_2S	X0XX X000b
0400F6h	Port P10_3 Function Select Register	P10_3S	0XXX X000b
0400F7h	Port P11_3 Function Select Register	P11_3S	X0XX X000b
0400F8h	Port P10_4 Function Select Register	P10_4S	0XXX X000b
0400F9h	Port P11_4 Function Select Register	P11_4S	XXXX X000b
0400FAh	Port P10_5 Function Select Register	P10_5S	0XXX X000b
0400FBh			
0400FCh	Port P10_6 Function Select Register	P10_6S	0XXX X000b
0400FDh			
0400FEh	Port P10_7 Function Select Register	P10_7S	0XXX X000b
0400FFh			
040100h	Port P12_0 Function Select Register	P12_0S	X0XX X000b
040101h	Port P13_0 Function Select Register	P13_0S	XXXX X000b
040102h	Port P12_1 Function Select Register	P12_1S	X0XX X000b
040103h	Port P13_1 Function Select Register	P13_1S	XXXX X000b
040104h	Port P12_2 Function Select Register	P12_2S	X0XX X000b
040105h	Port P13_2 Function Select Register	P13_2S	XXXX X000b
040106h	Port P12_3 Function Select Register	P12_3S	X0XX X000b
040107h	Port P13_3 Function Select Register	P13_3S	XXXX X000b
040108h	Port P12_4 Function Select Register	P12_4S	XXXX X000b
040109h	Port P13_4 Function Select Register	P13_4S	XXXX X000b
04010Ah	Port P12_5 Function Select Register	P12_5S	XXXX X000b
04010Bh	Port P13_5 Function Select Register	P13_5S	XXXX X000b
04010Ch	Port P12_6 Function Select Register	P12_6S	XXXX X000b
04010Dh	Port P13_6 Function Select Register	P13_6S	XXXX X000b
04010Eh	Port P12_7 Function Select Register	P12_7S	XXXX X000b
04010Fh	Port P13_7 Function Select Register	P13_7S	XXXX X000b
040110h			
040111h	Port P15_0 Function Select Register	P15_0S	00XX X000b
040112h			
040113h	Port P15_1 Function Select Register	P15_1S	00XX X000b
040114h			
040115h	Port P15_2 Function Select Register	P15_2S	00XX X000b
040116h	Port P14_3 Function Select Register	P14_3S	XXXX X000b
040117h	Port P15_3 Function Select Register	P15_3S	00XX X000b
040118h	Port P14_4 Function Select Register	P14_4S	XXXX X000b
040119h	Port P15_4 Function Select Register	P15_4S	00XX X000b
04011Ah	Port P14_5 Function Select Register	P14_5S	XXXX X000b
04011Bh	Port P15_5 Function Select Register	P15_5S	00XX X000b
04011Ch	Port P14_6 Function Select Register	P14_6S	XXXX X000b
04011Dh	Port P15_6 Function Select Register	P15_6S	00XX X000b
04011Eh			
04011Fh	Port P15_7 Function Select Register	P15_7S	00XX X000b

X: Undefined

Blanks are reserved. No access is allowed.

Table 4.27 SFR List (27)

Address	Register	Symbol	Reset Value
047C30h	CAN0 Mailbox 3: Message Identifier	C0MB3	XXXX XXXXh
047C31h			
047C32h			
047C33h			
047C34h			
047C35h	CAN0 Mailbox 3: Data Length		XXh
047C36h	CAN0 Mailbox 3: Data Field		XXXX XXXX XXXX XXXXh
047C37h			
047C38h			
047C39h			
047C3Ah			
047C3Bh			
047C3Ch			
047C3Dh			
047C3Eh	CAN0 Mailbox 3: Time Stamp		XXXXh
047C3Fh			
047C40h	CAN0 Mailbox 4: Message Identifier	C0MB4	XXXX XXXXh
047C41h			
047C42h			
047C43h			
047C44h			
047C45h	CAN0 Mailbox 4: Data Length		XXh
047C46h	CAN0 Mailbox 4: Data Field		XXXX XXXX XXXX XXXXh
047C47h			
047C48h			
047C49h			
047C4Ah			
047C4Bh			
047C4Ch			
047C4Dh			
047C4Eh	CAN0 Mailbox 4: Time Stamp		XXXXh
047C4Fh			
047C50h	CAN0 Mailbox 5: Message Identifier	C0MB5	XXXX XXXXh
047C51h			
047C52h			
047C53h			
047C54h			
047C55h	CAN0 Mailbox 5: Data Length		XXh
047C56h	CAN0 Mailbox 5: Data Field		XXXX XXXX XXXX XXXXh
047C57h			
047C58h			
047C59h			
047C5Ah			
047C5Bh			
047C5Ch			
047C5Dh			
047C5Eh	CAN0 Mailbox 5: Time Stamp		XXXXh
047C5Fh			

X: Undefined

Blanks are reserved. No access is allowed.

Table 4.30 SFR List (30)

Address	Register	Symbol	Reset Value
047CC0h	CAN0 Mailbox 12: Message Identifier	C0MB12	XXXX XXXXh
047CC1h			
047CC2h			
047CC3h			
047CC4h			
047CC5h	CAN0 Mailbox 12: Data Length		XXh
047CC6h	CAN0 Mailbox 12: Data Field		XXXX XXXX XXXX XXXXh
047CC7h			
047CC8h			
047CC9h			
047CCAh			
047CCBh			
047CCCh			
047CCDh			
047CCEh	CAN0 Mailbox 12: Time Stamp		XXXXh
047CCFh			
047CD0h	CAN0 Mailbox 13: Message Identifier	C0MB13	XXXX XXXXh
047CD1h			
047CD2h			
047CD3h			
047CD4h			
047CD5h	CAN0 Mailbox 13: Data Length		XXh
047CD6h	CAN0 Mailbox 13: Data Field		XXXX XXXX XXXX XXXXh
047CD7h			
047CD8h			
047CD9h			
047CDAh			
047CDBh			
047CDCh			
047CDDh			
047CDEh	CAN0 Mailbox 13: Time Stamp		XXXXh
047CDFh			
047CE0h	CAN0 Mailbox 14: Message Identifier	C0MB14	XXXX XXXXh
047CE1h			
047CE2h			
047CE3h			
047CE4h			
047CE5h	CAN0 Mailbox 14: Data Length		XXh
047CE6h	CAN0 Mailbox 14: Data Field		XXXX XXXX XXXX XXXXh
047CE7h			
047CE8h			
047CE9h			
047CEAh			
047CEBh			
047CECh			
047CEDh			
047CEEh	CAN0 Mailbox 14: Time Stamp		XXXXh
047CEFh			

X: Undefined

Blanks are reserved. No access is allowed.

Table 5.7 Electrical Characteristics of RAM
($V_{CC} = 3.0$ to 5.5 V, $V_{SS} = 0$ V, and $T_a = T_{opr}$, unless otherwise noted)

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
V_{RDR}	RAM data retention voltage	In stop mode	2.0			V

Table 5.8 Electrical Characteristics of Flash Memory
($V_{CC} = 3.0$ to 5.5 V, $V_{SS} = 0$ V, and $T_a = T_{opr}$, unless otherwise noted)

Symbol	Characteristic		Value			Unit
			Min.	Typ.	Max.	
—	Program/erase cycles (1)	Program area	1000			Cycles
		Data area	10000			Cycles
—	4-word program time	Program area		150	900	μ s
		Data area		300	1700	μ s
—	Lock bit program time	Program area		70	500	μ s
		Data area		140	1000	μ s
—	Block erasure time	4-Kbyte block		0.12	3.0	s
		32-Kbyte block		0.17	3.0	s
		64-Kbyte block		0.20	3.0	s
—	Data retention (2)	$T_a = 55^\circ\text{C}$ (3)	10			Years

Notes:

1. Program/erase definition

This value represents the number of erasures per block.

When the number of program/erase cycles is n, each block can be erased n times.

For example, if a 4-word write is performed in 512 different addresses in the 4-Kbyte block A and then the block is erased, this is counted as a single program/erase operation.

However, the same address cannot be written to more than once per erasure (overwrite disabled).

2. Data retention includes periods when no supply voltage is applied and no clock is provided.

3. Contact a Renesas Electronics sales office for data retention times other than the above condition.

$$V_{CC} = 5\text{ V}$$

Table 5.15 Electrical Characteristics (1/3)

($V_{CC} = 4.2$ to 5.5 V , $V_{SS} = 0\text{ V}$, $T_a = T_{opr}$, and $f_{(CPU)} = 64\text{ MHz}$, unless otherwise noted)

Symbol	Characteristic		Measurement Condition	Value			Unit
				Min.	Typ.	Max.	
V_{OH}	High level output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OH} = -5\text{ mA}$	$V_{CC} - 2.0$		V_{CC}	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OH} = -200\text{ }\mu\text{A}$	$V_{CC} - 0.3$		V_{CC}	V
V_{OL}	Low level output voltage	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OL} = 5\text{ mA}$			2.0	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_4, P12_0 to P12_7, P13_0 to P13_7, P14_3 to P14_6, P15_0 to P15_7 (1)	$I_{OL} = 200\text{ }\mu\text{A}$			0.45	V

Note:

- Ports P9_0, P9_2, and P11 to P15 are available in the 144-pin package only. Port P9_1 is designated as input pin in the 100-pin package.

$$V_{CC} = 5 \text{ V}$$

Table 5.18 A/D Conversion Characteristics ($V_{CC} = AV_{CC} = V_{REF} = 4.2 \text{ to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $T_a = T_{opr}$, and $f_{(BCLK)} = 32 \text{ MHz}$, unless otherwise noted)

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
—	Resolution	$V_{REF} = V_{CC}$			10	Bits
—	Absolute error	$V_{REF} = V_{CC} = 5 \text{ V}$			± 3	LSB
		AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7, ANEX0, ANEX1 ⁽¹⁾ External op-amp connection mode			± 7	LSB
INL	Integral non-linearity error	$V_{REF} = V_{CC} = 5 \text{ V}$			± 3	LSB
		AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7, ANEX0, ANEX1 ⁽¹⁾ External op-amp connection mode			± 7	LSB
DNL	Differential non-linearity error				± 1	LSB
—	Offset error				± 3	LSB
—	Gain error				± 3	LSB
R_{LADDER}	Resistor ladder	$V_{REF} = V_{CC}$	4		20	k Ω
t_{CONV}	Conversion time (10 bits)	$\phi_{AD} = 16 \text{ MHz}$, with sample and hold function	2.06			μs
		$\phi_{AD} = 16 \text{ MHz}$, without sample and hold function	3.69			μs
t_{CONV}	Conversion time (8 bits)	$\phi_{AD} = 16 \text{ MHz}$, with sample and hold function	1.75			μs
		$\phi_{AD} = 16 \text{ MHz}$, without sample and hold function	3.06			μs
t_{SAMP}	Sampling time	$\phi_{AD} = 16 \text{ MHz}$	0.188			μs
V_{IA}	Analog input voltage		0		V_{REF}	V
ϕ_{AD}	Operating clock frequency	Without sample and hold function	0.25		16	MHz
		With sample and hold function	1		16	MHz

Note:

1. Pins AN15_0 to AN15_7 are available in the 144-pin package only.

$$V_{CC} = 5\text{ V}$$

Timing Requirements ($V_{CC} = 4.2$ to 5.5 V , $V_{SS} = 0\text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.30 Serial Interface

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(CK)}$	CLKi input clock cycle time	200		ns
$t_{W(CKH)}$	CLKi input high level pulse width	80		ns
$t_{W(CKL)}$	CLKi input low level pulse width	80		ns
$t_{Su(D-C)}$	RXD _i input setup time	80		ns
$t_{h(C-D)}$	RXD _i input hold time	90		ns

Table 5.31 A/D Trigger Input

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{W(ADH)}$	ADTRG input high level pulse width Hardware trigger input high level pulse width	$\frac{3}{\phi_{AD}}$		ns
$t_{W(ADL)}$	ADTRG input low level pulse width Hardware trigger input high level pulse width	125		ns

Table 5.32 External Interrupt $\overline{INT}_i$ Input

Symbol	Characteristic		Value		Unit
			Min.	Max.	
$t_{W(INH)}$	$\overline{INT}_i$ input high level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{C(CPU)} + 200$		ns
$t_{W(INL)}$	$\overline{INT}_i$ input low level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{C(CPU)} + 200$		ns

Table 5.33 Intelligent I/O

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(ISCLK2)}$	ISCLK2 input clock cycle time	600		ns
$t_{W(ISCLK2H)}$	ISCLK2 input high level pulse width	270		ns
$t_{W(ISCLK2L)}$	ISCLK2 input low level pulse width	270		ns
$t_{Su(RXD-ISCLK2)}$	ISRXD2 input setup time	150		ns
$t_{h(ISCLK2-RXD)}$	ISRXD2 input hold time	100		ns

$$V_{CC} = 5 \text{ V}$$

Switching Characteristics ($V_{CC} = 4.2$ to 5.5 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.35 External Bus Timing (separate bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-R)}$	Chip-select setup time before read	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		$t_{c(Base)} - 15$		ns
$t_{su(A-R)}$	Address setup time before read		(1)		ns
$t_{h(R-A)}$	Address hold time after read		$t_{c(Base)} - 15$		ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{su(S-W)}$	Chip-select setup time before write		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{su(A-W)}$	Address setup time before write		(1)		ns
$t_{h(W-A)}$	Address hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		0		ns

Note:

1. The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of $T_{su(A-R)}$, $T_{w(R)}$, $T_{su(A-W)}$, and $T_{w(W)}$ set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

$$t_{su(S-R)} = t_{su(A-R)} = T_{su(A-R)} \times t_{c(Base)} - 15 \text{ [ns]}$$

$$t_{w(R)} = T_{w(R)} \times t_{c(Base)} - 10 \text{ [ns]}$$

$$t_{su(S-W)} = t_{su(A-W)} = T_{su(A-W)} \times t_{c(Base)} - 15 \text{ [ns]}$$

$$t_{w(W)} = t_{su(D-W)} = T_{w(W)} \times t_{c(Base)} - 10 \text{ [ns]}$$

$$V_{CC} = 5 \text{ V}$$

Switching Characteristics ($V_{CC} = 4.2$ to 5.5 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.37 Serial Interface

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(C-Q)}$	TXDi output delay time	Refer to Figure 5.6		80	ns
$t_{h(C-Q)}$	TXDi output hold time		0		ns

Table 5.38 Intelligent I/O

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(ISCLK2-TXD)}$	ISTXD2 output delay time	Refer to Figure 5.6		180	ns
$t_{h(ISCLK2-RXD)}$	ISTXD2 output hold time		0		ns

Table 5.39 Multi-master I²C-bus Interface (standard-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2		ns
$t_{f(SDA)}$	MSDA output fall time		2		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$20 \times t_{C(\phi IIC)} - 120$	$52 \times t_{C(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$20 \times t_{C(\phi IIC)} + 40$	$52 \times t_{C(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{C(\phi IIC)} + 40$	$3 \times t_{C(\phi IIC)} + 120$	ns

Table 5.40 Multi-master I²C-bus Interface (fast-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2 (1)		ns
$t_{f(SDA)}$	MSDA output fall time		2 (1)		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$10 \times t_{C(\phi IIC)} - 120$	$26 \times t_{C(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$10 \times t_{C(\phi IIC)} + 40$	$26 \times t_{C(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{C(\phi IIC)} + 40$	$3 \times t_{C(\phi IIC)} + 120$	ns

Note:

1. External circuits are required to satisfy the I²C-bus specification.

$$V_{CC} = 3.3 \text{ V}$$

Timing Requirements ($V_{CC} = 3.0$ to 3.6 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.56 Serial Interface

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(CK)}$	CLKi input clock cycle time	200		ns
$t_{W(CKH)}$	CLKi input high level pulse width	80		ns
$t_{W(CKL)}$	CLKi input low level pulse width	80		ns
$t_{su(D-C)}$	RXDi input setup time	80		ns
$t_{h(C-D)}$	RXDi input hold time	90		ns

Table 5.57 A/D Trigger Input

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{W(ADH)}$	ADTRG input high level pulse width Hardware trigger input high level pulse width	$\frac{3}{\phi_{AD}}$		ns
$t_{W(ADL)}$	ADTRG input low level pulse width Hardware trigger input high level pulse width	125		ns

Table 5.58 External Interrupt $\overline{INTi}$ Input

Symbol	Characteristic		Value		Unit
			Min.	Max.	
$t_{W(INH)}$	$\overline{INTi}$ input high level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{C(CPU)} + 200$		ns
$t_{W(INL)}$	$\overline{INTi}$ input low level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{C(CPU)} + 200$		ns

Table 5.59 Intelligent I/O

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{C(ISCLK2)}$	ISCLK2 input clock cycle time	600		ns
$t_{W(ISCLK2H)}$	ISCLK2 input high level pulse width	270		ns
$t_{W(ISCLK2L)}$	ISCLK2 input low level pulse width	270		ns
$t_{su(RXD-ISCLK2)}$	ISRXD2 input setup time	150		ns
$t_{h(ISCLK2-RXD)}$	ISRXD2 input hold time	100		ns

$$V_{CC} = 3.3 \text{ V}$$

Switching Characteristics ($V_{CC} = 3.0$ to 3.6 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.62 External Bus Timing (multiplexed bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-ALE)}$	Chip-select setup time before ALE	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		$1.5 \times t_{c(Base)} - 15$		ns
$t_{su(A-ALE)}$	Address setup time before ALE		(1)		ns
$t_{h(ALE-A)}$	Address hold time after ALE		$0.5 \times t_{c(Base)} - 5$		ns
$t_{h(R-A)}$	Address hold time after read		$1.5 \times t_{c(Base)} - 15$		ns
$t_{d(ALE-R)}$	ALE-read delay time		$0.5 \times t_{c(Base)} - 5$	$0.5 \times t_{c(Base)} + 10$	ns
$t_{w(ALE)}$	ALE pulse width		(1)		ns
$t_{dis(R-A)}$	Address disable time after read			8	ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{h(W-A)}$	Address hold time after write		$1.5 \times t_{c(Base)} - 15$		ns
$t_{d(ALE-W)}$	ALE-write delay time		$0.5 \times t_{c(Base)} - 5$	$0.5 \times t_{c(Base)} + 10$	ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		$0.5 \times t_{c(Base)}$		ns

Note:

1. The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of $T_{su(A-R)}$, $T_w(R)$, $T_{su(A-W)}$, and $T_w(W)$ set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

$$t_{su(S-ALE)} = t_{su(A-ALE)} = (T_{su(A-R)} - 0.5) \times t_{c(Base)} - 15 \text{ [ns]}$$

$$t_{w(ALE)} = (T_{su(A-R)} - 0.5) \times t_{c(Base)} - 20 \text{ [ns]}$$

$$t_{w(R)} = T_w(R) \times t_{c(Base)} - 10 \text{ [ns]}$$

$$t_{w(W)} = t_{su(D-W)} = T_w(W) \times t_{c(Base)} - 10 \text{ [ns]}$$

$$V_{CC} = 3.3 \text{ V}$$

Switching Characteristics ($V_{CC} = 3.0$ to 3.6 V , $V_{SS} = 0 \text{ V}$, and $T_a = T_{opr}$, unless otherwise noted)

Table 5.63 Serial Interface

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(C-Q)}$	TXDi output delay time	Refer to Figure 5.6		80	ns
$t_{h(C-Q)}$	TXDi output hold time		0		ns

Table 5.64 Intelligent I/O

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{d(ISTXK2-TXD)}$	ISTXD2 output delay time	Refer to Figure 5.6		180	ns
$t_{h(ISTXK2-RXD)}$	ISTXD2 output hold time		0		ns

Table 5.65 Multi-master I²C-bus Interface (Standard-mode)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2		ns
$t_{f(SDA)}$	MSDA output fall time		2		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$20 \times t_{c(\phi IIC)} - 120$	$52 \times t_{c(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$20 \times t_{c(\phi IIC)} + 40$	$52 \times t_{c(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{c(\phi IIC)} + 40$	$3 \times t_{c(\phi IIC)} + 120$	ns

Table 5.66 Multi-master I²C-bus Interface (Fast-mode)

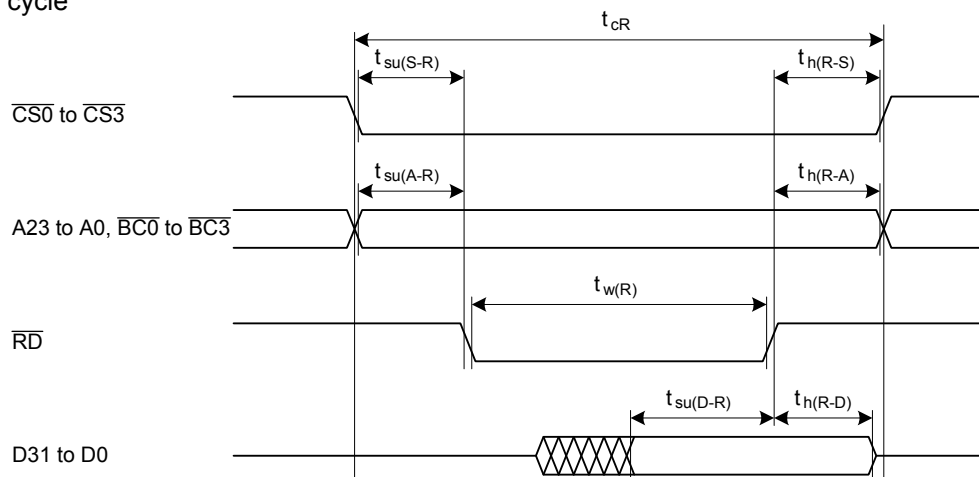
Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{f(SCL)}$	MSCL output fall time	Refer to Figure 5.6	2 (1)		ns
$t_{f(SDA)}$	MSDA output fall time		2 (1)		ns
$t_{d(SDA-SCL)S}$	MSCL output delay time after START condition/repeated START condition		$10 \times t_{c(\phi IIC)} - 120$	$26 \times t_{c(\phi IIC)} - 40$	ns
$t_{d(SCL-SDA)P}$	Repeated START condition/STOP condition output delay time after MSCL becomes high		$10 \times t_{c(\phi IIC)} + 40$	$26 \times t_{c(\phi IIC)} + 120$	ns
$t_{d(SCL-SDA)}$	MSDA output delay time		$2 \times t_{c(\phi IIC)} + 40$	$3 \times t_{c(\phi IIC)} + 120$	ns

Note:

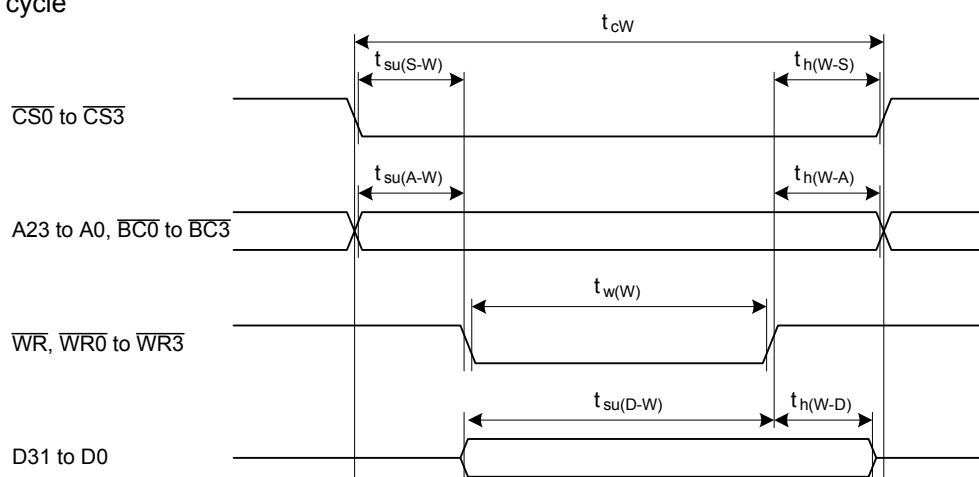
1. External circuits are required to satisfy the I²C-bus specification.

External bus timing (separate bus)

Read cycle



Write cycle



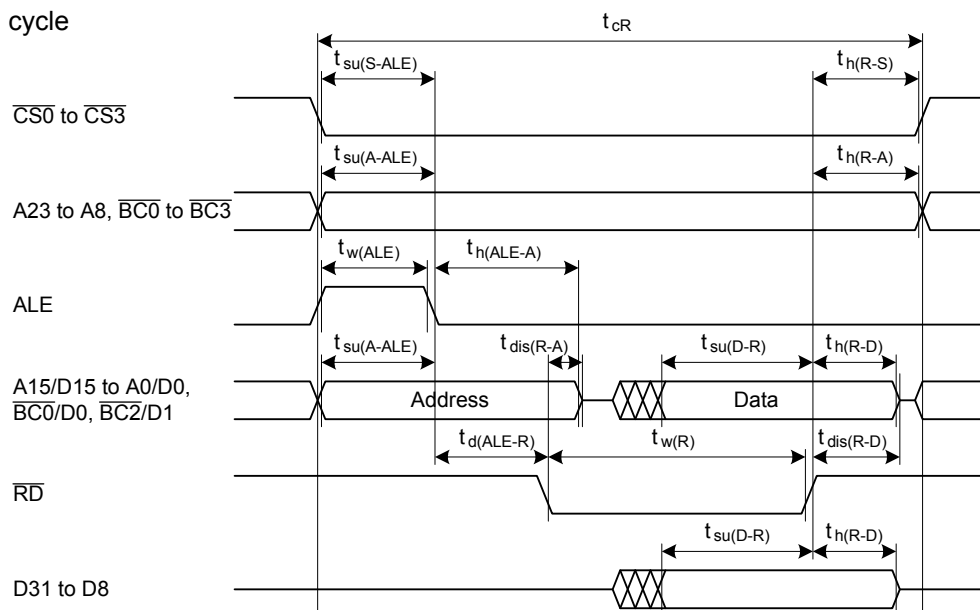
Measurement conditions

Item		$V_{CC} = 4.2$ to 5.5 V	$V_{CC} = 3.0$ to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

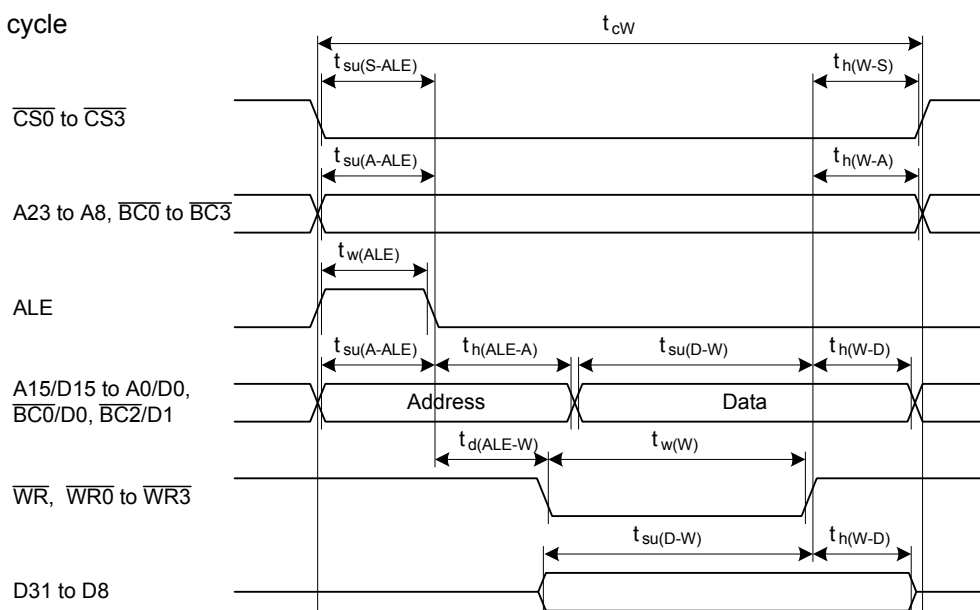
Figure 5.8 External Bus Timing for Separate Bus

External bus timing (multiplexed bus)

Read cycle



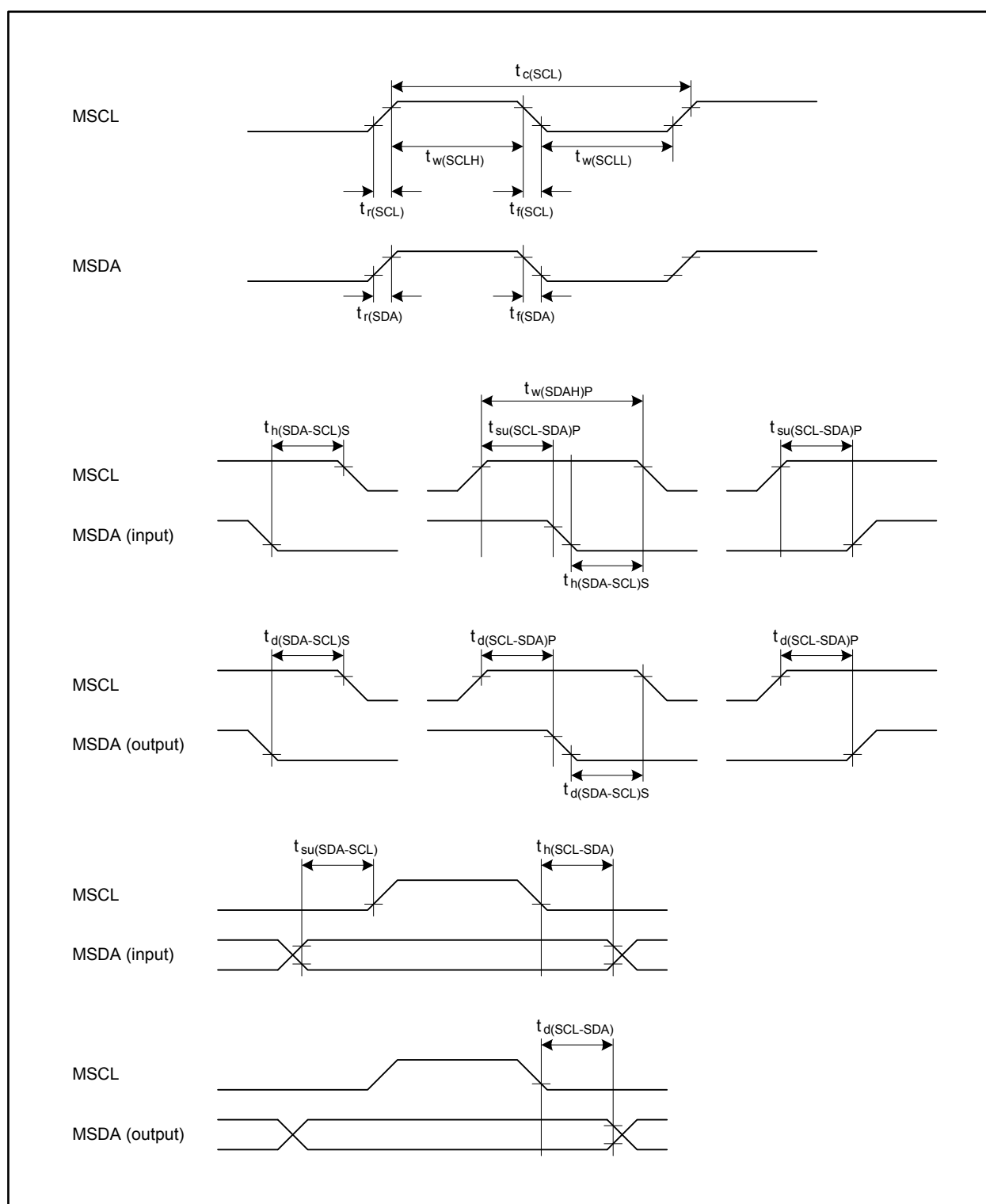
Write cycle



Measurement conditions

Item		$V_{CC} = 4.2$ to 5.5 V	$V_{CC} = 3.0$ to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

Figure 5.9 External Bus Timing for Multiplexed Bus

Figure 5.11 Timing of Multi-master I²C-bus Interface